PATENT MCRO:125 94-0281/95-0025

DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or the below named inventors are the original, first and joint inventors (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "A METHOD FOR FORMING CONDUCTORS IN SEMICONDUCTOR DEVICES" the specification of which:

XXX	is attached hereto.		
	was filed on	as Application Serial No.	

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims.

I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

	PRIOR FOREIGN APPLICATION(S)		Priority Claimed
(Number)	(Country)	(Date Filed)	Yes/No
(Number)	(Country)	(Date Filed)	Yes/No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose all information known to me to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations, § 1.56, which

become available between the filing date of the prior application and the national or PCT
international filing date of this application:

(Application.Serial No.)		(F	iling Date)	(Status)
I hereby direct that all correspondence and telephone calls be addressed to Todd D. Mattingly, Arnold, White & Durkee, P.O. Box 4433, Houston, Texas 77210 (713) 787-1400, attorneys for the prospective assignee of this application.				
I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.				
Inventor's Full Name:		[N.M.I]		GONZALEZ
	(First)	(Initial)		(Last)
Inventor's Signature:	Thumb	Honsal	<u>.</u>	
Date: 2/16/96		Country of	of Citizenship:	United States of America
Residence Address:	2579 S. Flotilla Aver (Include number, stre			
Post Office Address				
(if different from residence address)				
Inventor's Full Name:	GURTEJ	S		SANDHU
	(First)	(Initial)		(Last)
Inventor's Signature:	- (Dimf	Sas	San	
Date: 2/10/	98	Country	of Citizenship:	United Kingdom
Residence Address:	Residence Address: 2964 E. Parkriver Drive, Boise, Idaho 83705 U.S.A.			J.S.A.
(Include number, street name, city, state, and country)				

Post Office Address ________(if different from residence address) _______

Inventor's Full Name:	MIKE	P.	VIOLETTE
	(First)	(Initial)	(Last)
Inventor's Signature:	Mile	P. Viole	tt
Date: 2/16/94	2	Country of Ci	tizenship: <u>United States of America</u>
Residence Address:		vood Court, Boise, Id	
	(Include numbe	er, street name, city, s	ate, and country)
Post Office Address _ (if different from resid	lence address)		
(II GILLOTOTIC HOTH 10510			

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In re Ap	plication of: Fernando Gonzalez et al.	§ § §	Group Art Unit:	1104		
Serial N	o.: 08/604,751	§	Evei			
Filed:	February 23, 1996	§ §	Examiner:			
For:	METHOD FOR FORMING CONDUCTO IN SEMICONDUCTOR DEVICES	RS § § §	Atty Docket:	MCRO:125/FLE 94-0281 and 95-0025		
		UNDER 37 C.F.I POWER OF A	R. §§ 3.71 AND 3.7 FTORNEY	3		
	t Commissioner for Patents gton, D.C. 20231					
Sir:	•					
prosecut	The undersigned, being Assignee of the end in the United States Patent and Trademark te the application to the exclusion of the investment	Office as set fort	above-identified ap h below, hereby ele	oplication by virtue of an Assignment cts, under 37 C.F.R. § 3.71, to		
	The Assignee hereby revokes any previous	Powers of Attorn	ney and appoints:			
lat.	Michael L. Lynch, Reg. No. 30,871; and Lia Pappas Dennison, Reg. No. 34,095					
⊈ þ£MICF	MICRON TECHNOLOGY, INC. as Attorneys of Record in the captioned application; and also					
III						
Iffms, w transa year afte MICRO	attorney with the law firm of FLETCHER & ith full power of substitution and revocation ct all business in the Patent and Trademark issuance of such Letters Patent to file any Pursuant to 37 C.F.R. § 3.73, the undersign NTECHNOLOGY, INC. referenced below,	thoneycutt, to prosecute the Office in connect request for a cert ed has reviewed	P.C. as its attorney, application, to make tion therewith, to relificate of correction the evidentiary documents.	s so long as they remain with such the alterations and amendments therein, ceive any Letters Patent, and for one that may be deemed appropriate.		
the name	e of the Assignee. Please dire	ct all communic	ations as follows:			
	FLETC P.O. Bo Spring,	l G. Fletcher HER & HONEY ox 11850 TX 77391-1850 70-4545				
		ASSIC	GNEE: Micron Tecl	hnology, Inc.		
Date: _	CJ 25, 1996	By: _ Name:	Michael L. Lynch	Chief Patent Counsel		
ASSIGN	MENT:					
	Enclosed for recording					

____ Enclosed for recording X Previously recorded:

Date: February 23, 1996 Reel: 7889

Frame: 0678

PATENT MCRO:125 94-0281/95-0025

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do_ hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. (the "Assignee"), a corporation of Delaware having a place of business at 2805 East Columbia Road, Boise, Idaho 83706-9698, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "A METHOD FOR FORMING CONDUCTORS IN SEMICONDUCTOR DEVICES" such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for vesting title to such improvements in the Assignee, and for securing, maintaining and enforcing proper patent protection for such improvements;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature: Jemanh Aonida
Name: FERNANDO, GONZALEZ

Signature: 97 mf Signature
Name: GURTEJ S. SANDHU

Signature: 10/16/96

Name: MIKE P. VIOLETTE

STATE OF Idaho	§
COUNTY OF ada	§ ss. §
me to be the person	the undersigned authority, on this lost day of Frinary 19 96 To inardo Gonzalez known to whose name is subscribed to the foregoing instrument and acknowledged to me ted the same of his own free will for the purposes and consideration Notary or Consular Officer Residing in Boise, idaho My Commission expires 9-8-2000
STATE OF	§ § ss.
COUNTY OF	§
BEFORE ME personally appeared me to be the person_ that executherein expressed	E, the undersigned authority, on this Hoth day of Abruary, 19 96 Livity, S. Sandhu known to whose name is subscribed to the foregoing instrument and acknowledged to me uted the same of his own free will for the purposes and consideration Notary or Consular Officer Residing in Boise, Idaho My Commission expires 9-8-2000
STATE OF TOTAL	
COUNTY OF	§ SS
personally appeared me to be the person_	E, the undersigned authority, on this left day of Lohnward, 1996 Mike Violotta. known to whose name issubscribed to the foregoing instrument and acknowledged to me uted the same of his own free will for the purposes and consideration Notary or Consular Officer Residing in Boise, Idaho
The same of the sa	My Commission expires 9-8-2000